



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

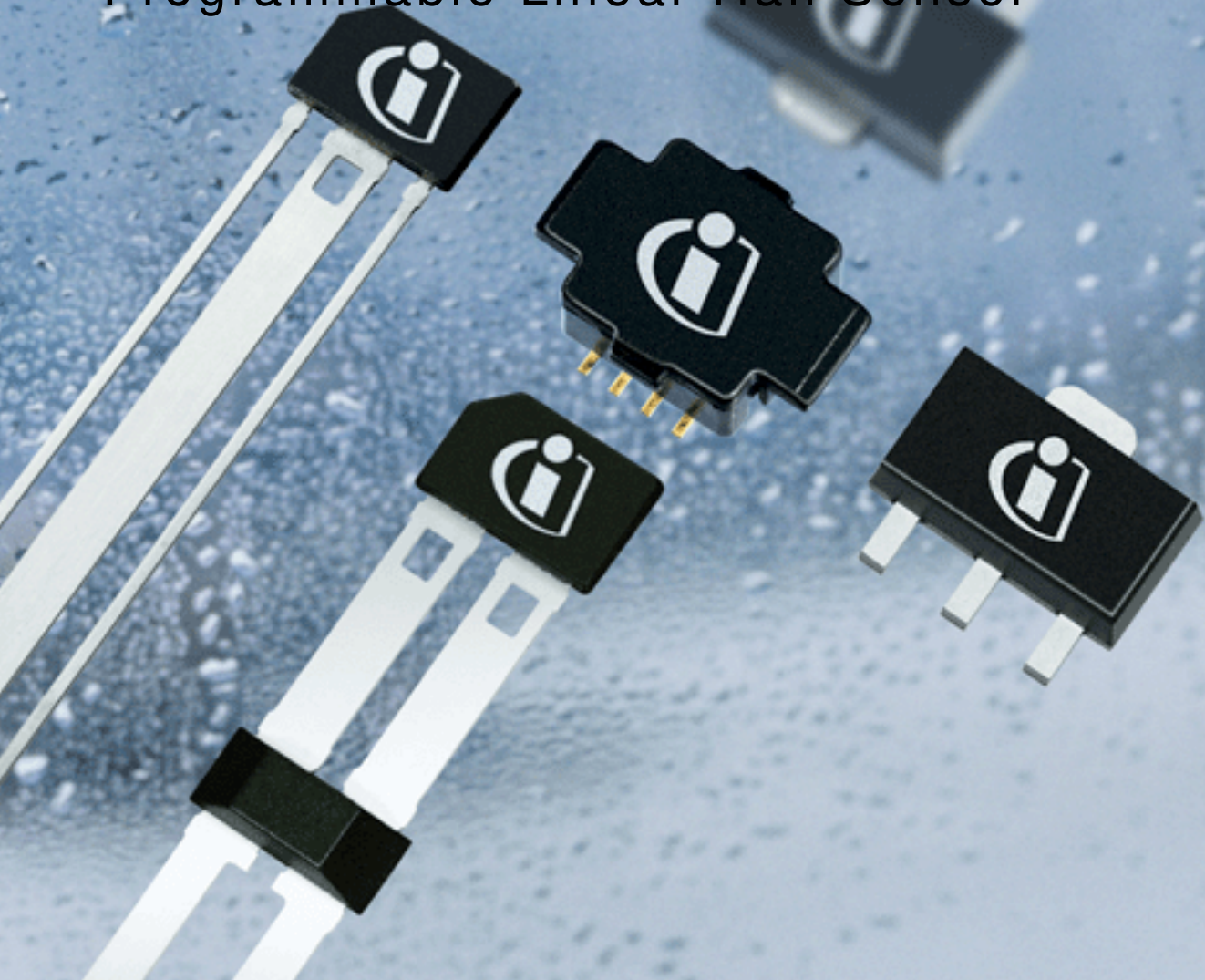
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



TLE4998C3C

Programmable Linear Hall Sensor



Sensors



Never stop thinking.

Edition 2009-09

**Published by Infineon Technologies AG,
Am Campeon 1-12,
85579 Neubiberg, Germany**

**© Infineon Technologies AG 2009.
All Rights Reserved.**

Attention please!

The information herein is given to describe certain components and shall not be considered as a guarantee of characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Revision History: **2009-09**

Rev 1.1

Previous Version: Data Sheet Rev 1.0

Page	Subjects (major changes since last revision)
Page 13	Table 4: Footnote 3) adapted
Page 15	Table 5: Sensitivity drift description adapted
Page 15	Table 5: Footnote 3) adapted
Page 25	Table 14: Footnote 1) and 2) adapted
General	Package nomenclature changed to PG-SSO-3-92

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all?
Your feedback will help us to continuously improve the quality of this document.

Please send your proposal (including a reference to this document) to:

sensors@infineon.com



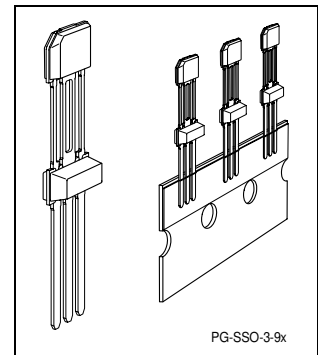
1	Overview	6
1.1	Features	6
1.2	Target Applications	7
1.3	Pin Configuration	7
2	General	8
2.1	Block Diagram	8
2.2	Functional Description	8
2.3	Principle of Operation	9
2.4	Transfer Functions	10
3	Maximum Ratings	11
4	Operating Range	12
5	Electrical, Thermal, and Magnetic Parameters	13
	Calculation of the Junction Temperature	15
	Magnetic Parameters	15
6	Signal Processing	17
	Magnetic Field Path	17
	Temperature Compensation	17
6.1	Magnetic Field Ranges	18
6.2	Gain Setting	19
6.3	Offset Setting	19
6.4	DSP Input Low-Pass Filter	20
6.5	Clamping	22
7	Error Detection	24
7.1	Voltages Outside the Operating Range	24
7.2	EEPROM Error Correction	24
8	Temperature Compensation	25
8.1	Parameter Calculation	26
9	Calibration	27
9.1	Calibration Data Memory	28
9.2	Programming Interface	29
9.3	Data Transfer Protocol	29
9.4	Programming of Sensors with Common Supply Lines	29
10	Application Circuit	30
11	PG-SSO-3-92 Package Outlines	31
12	SPC Output Definition	32
12.1	Basic SPC Protocol Definition	32
12.2	Unit Time Setup	34
12.3	Master Pulse Requirements	35

12.4	Synchronous Transmission	37
12.5	Synchronous Transmission Including Range Selection	37
12.6	Synchronous Mode with ID Selection	38
12.7	Checksum Nibble Details	41

1 Overview

1.1 Features

- SPC (Short PWM Code) protocol with enhanced interface features based on SENT (Single Edge Nibble Transmission, defined by SAE J2716)
- 20-bit Digital Signal Processing (DSP)
- Digital temperature compensation
- 16-bit overall resolution
- Operates within automotive temperature range
- Low drift of output signal over temperature and lifetime
- Programmable parameters stored in EEPROM with single-bit error correction:
 - SPC protocol modes: synchronous transmission, dynamic range selection, ID selection mode
 - SPC unit time
 - Magnetic range and sensitivity (gain), polarity of the output slope
 - Offset
 - Bandwidth
 - Clamping levels
 - Customer temperature compensation coefficients
 - Memory lock
- Re-programmable until memory lock
- Supply voltage 4.5 - 5.5 V (4.1 - 16 V extended range)
- Operation between -200 mT and +200 mT within three ranges
- Reverse-polarity and overvoltage protection for all pins
- Output short-circuit protection
- On-board diagnostics (overvoltage, EEPROM error, start up)
- Output of internal magnetic field values and temperature
- Programming and operation of multiple sensors with common power supply
- Two-point calibration of magnetic transfer function without iteration steps
- High immunity against mechanical stress, EMC, ESD
- Package with two capacitors: 47nF (*VDD* to *GND*) and 4.7nF (*OUT* to *GND*)



Type	Marking	Ordering Code	Package
TLE4998C3C	98C3C	SP000481482	PG-SSO-3-92

1.2 Target Applications

- Robust replacement of potentiometers
 - No mechanical abrasion
 - Resistant to humidity, temperature, pollution and vibration
- Linear and angular position sensing in automotive applications such as pedal position, suspension control, throttle position, headlight levelling, and steering torque sensing
- Sensing of high current for battery management, motor control, and electronic fuses

1.3 Pin Configuration

Figure 1 shows the location of the Hall element in the chip and the distance between Hall probe and the surface of the package.

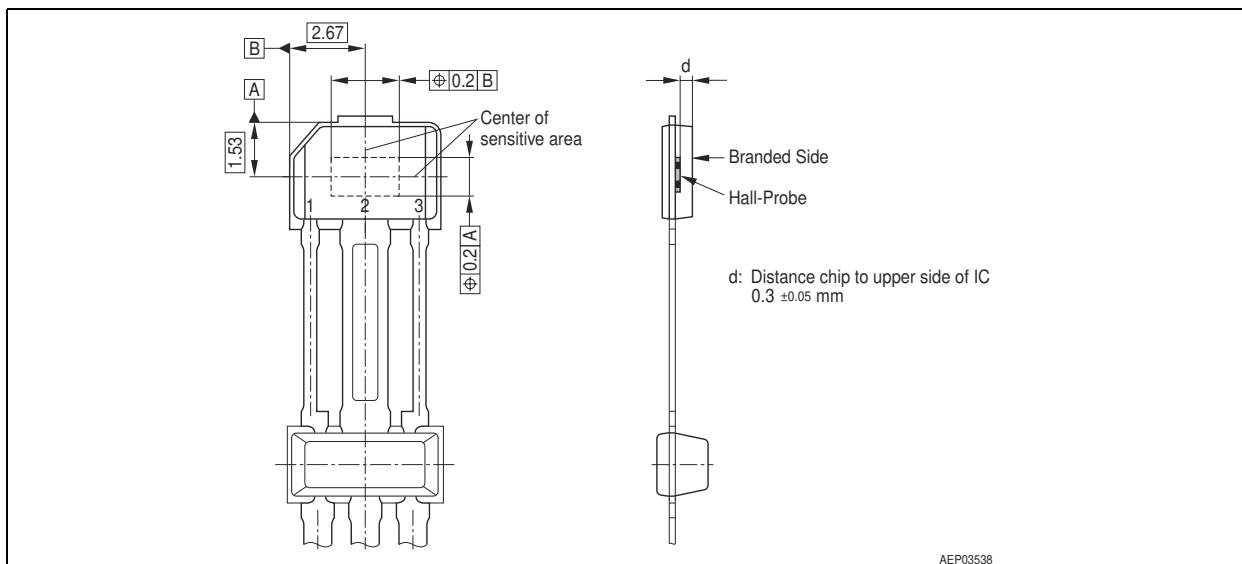


Figure 1 TLE4998x3C Pin Configuration and Hall Cell Location

Table 1 TLE4998C3C Pin Definitions and Functions

Pin No.	Symbol	Function
1	<i>VDD</i>	Supply voltage / programming interface
2	<i>GND</i>	Ground
3	<i>OUT</i>	Output / programming interface

2 General

2.1 Block Diagram

Figure 2 shows a simplified block diagram.

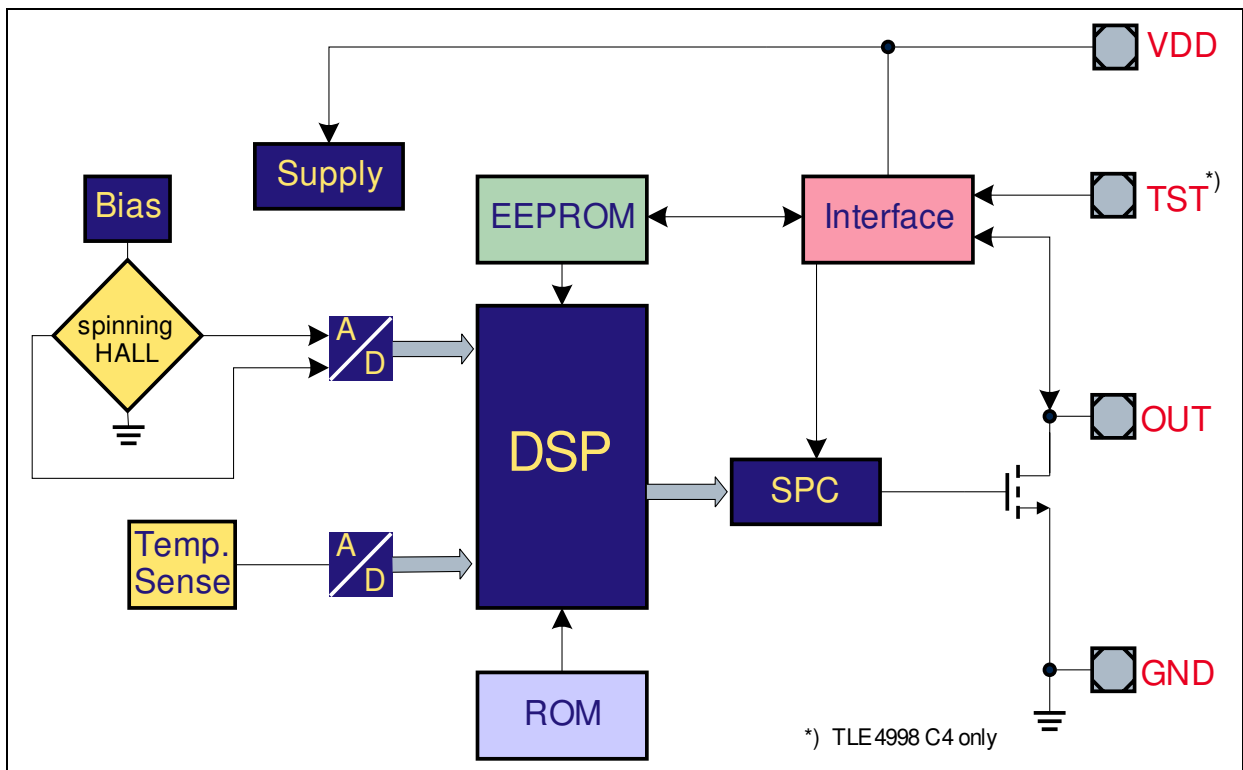


Figure 2 Block diagramm

2.2 Functional Description

The linear Hall IC TLE4998C3C has been designed specifically to meet the requirements of highly accurate angle and position detection as well as for current measurement applications. Two capacitors are integrated on the lead frame, making this sensor especially suitable for applications with demanding EMC requirements.

The sensor provides a digital SPC (Short PWM Code) signal, based on the standardized SENT (Single Edge Nibble Transmission, SAE J2716) protocol. The SPC protocol allows transmissions initiated by the ECU. Two further operation modes are available:

- “range selection” for dynamical switching of the measurement range during operation
- “ID selection” to build a bus system with up to 4 ICs on a single output line and a common supply, which can be individually accessed by the ECU.

Each transmission sequence contains an adjustable number of nibbles representing the magnetic field, the temperature value and a status information of the sensor. The

General

interface is further described in [Chapter 12](#). The output stage is an open-drain driver pulling the output pin to low only. Therefore, the high level needs to be obtained by an external pull-up resistor. This output type has the advantage that the receiver may use an even lower supply voltage (e.g. 3.3 V). In this case the pull-up resistor must be connected to the given receiver supply.

The IC is produced in BiCMOS technology with high voltage capability, and it also has reverse-polarity protection.

Digital signal processing using a 16-bit DSP architecture together with digital temperature compensation guarantee excellent long-time stability compared to analog compensation methods.

While the overall resolution is 16 bits, some internal stages work with resolutions up to 20 bits.

2.3 Principle of Operation

- A magnetic flux is measured by a Hall-effect cell
- The output signal from the Hall-effect cell is converted from analog to digital
- The chopped Hall-effect cell and continuous-time A/D conversion ensure a very low and stable magnetic offset
- A programmable low-pass filter to reduce noise
- The temperature is measured and A/D converted, too
- Temperature compensation is done digitally using a second-order function
- Digital processing of output value is based on zero field and sensitivity value
- The output value range can be clamped by digital limiters
- The final output value is represented by the data nibbles of the SPC protocol

2.4 Transfer Functions

The examples in **Figure 3** show how different magnetic field ranges can be mapped to the desired output value ranges.

- Polarity Mode:
 - **Bipolar:** Magnetic fields can be measured in both orientations. The limit points do not necessarily have to be symmetrical around the zero field point
 - **Unipolar:** Only north- or south-oriented magnetic fields are measured
- Inversion: The gain can be set to both positive and negative values

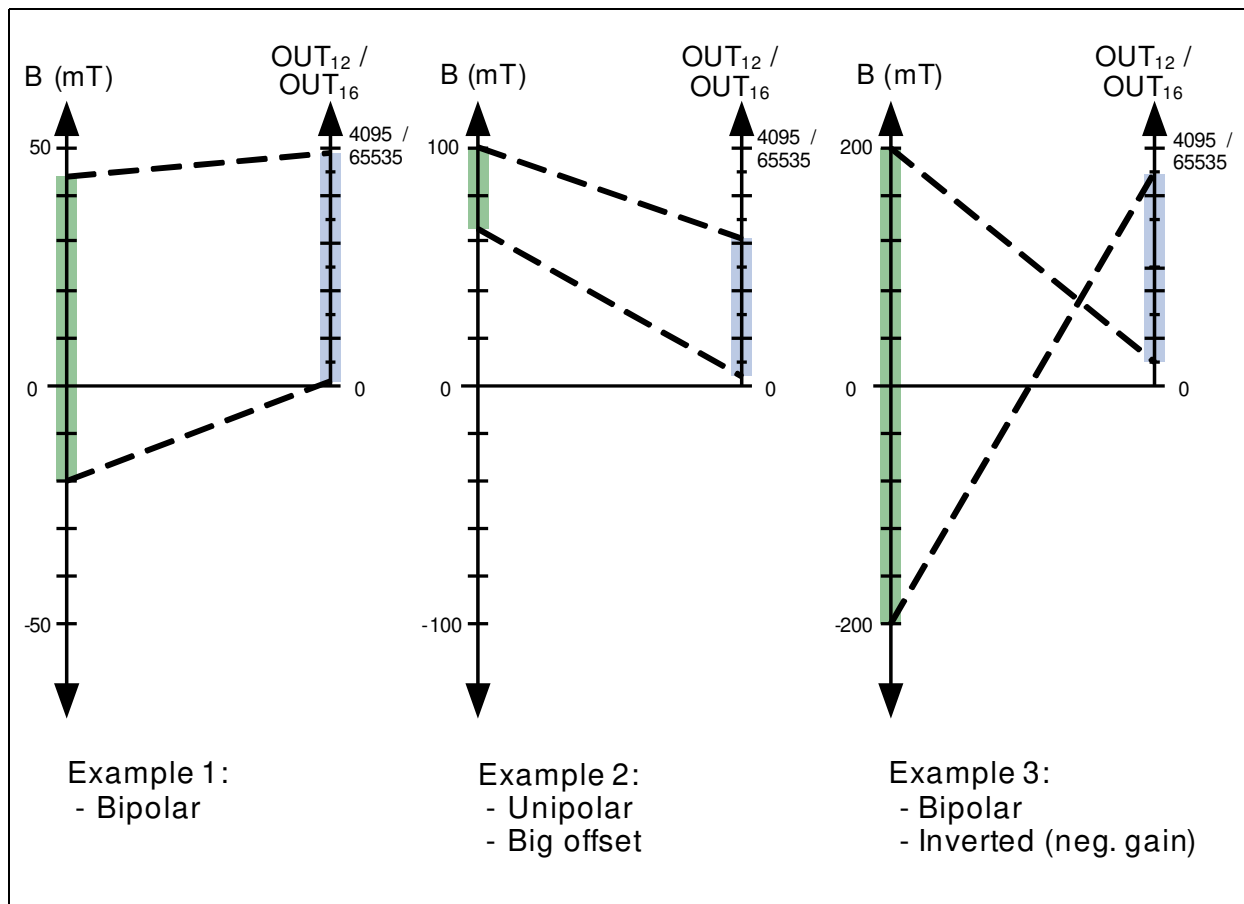


Figure 3 Examples of Operation

3 Maximum Ratings

Table 2 Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		
Storage temperature	T_{ST}	- 40	150	°C	
Junction temperature	T_J	- 40	170 ¹⁾	°C	
Voltage on V_{DD} pin with respect to ground	V_{DD}	-18	18	V	²⁾
Supply current @ overvoltage V_{DD} max.	I_{DDov}	-	15	mA	
Reverse supply current @ V_{DD} min.	I_{DDrev}	-1	0	mA	
Voltage on output pin with respect to ground	V_{OUT}	-1 ³⁾	18 ⁴⁾	V	
Magnetic field	B_{MAX}	-	unlimited	T	
ESD protection	V_{ESD}	-	8	kV	According HBM JESD22-A114-B ⁵⁾

- 1) For limited time of 96 h. Depends on customer temperature lifetime cycles. Please ask for support by Infineon
- 2) Higher voltage stress than absolute maximum rating, e.g. 150% in latch-up tests is not applicable. In such cases, $R_{series} \geq 100 \Omega$ for current limitation is required
- 3) I_{DD} can exceed 10 mA when the voltage on OUT is pulled below -1 V (-5 V at room temperature)
- 4) $V_{DD} = 5$ V, open drain permanent low, for max. 10 minutes
- 5) 100 pF and 1.5 k Ω

Note: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

4 Operating Range

The following operating conditions must not be exceeded in order to ensure correct operation of the TLE4998C3C. All parameters specified in the following sections refer to these operating conditions, unless otherwise indicated.

Table 3 Operating Range

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		
Supply voltage	V_{DD}	4.5	5.5	V	
		4.1 ¹⁾	16 ²⁾	V	Extended range
Output pull-up voltage ³⁾	$V_{pull-up}$	-	18	V	
Load resistance ³⁾	R_L	1	-	k Ω	
Output current ³⁾	I_{OUT}	0	5	mA	
Junction temperature	T_J	- 40	125 150 ⁴⁾	$^{\circ}\text{C}$	For 5000 h For 1000 h not additive

1) For reduced output accuracy

2) For supply voltages > 12 V, a series resistance $R_{series} \geq 100 \Omega$ is recommended

3) Output protocol characteristics depend on these parameters, R_L must be according to max. output current

4) For reduced magnetic accuracy; extended limits are taken for characteristics

Keeping signal levels within the limits specified in this table ensures operation without overload conditions.

Electrical, Thermal, and Magnetic Parameters
5 Electrical, Thermal, and Magnetic Parameters
Table 4 Electrical Characteristics

Parameter	Symbol	Limit Values			Unit	Notes
		min.	typ.	max.		
VDD-GND capacitor	C_{VDD}	-	47	-	nF	Ceramic
OUT-GND capacitor	C_L	-	4.7	-	nF	Ceramic
SPC transmission time	t_{SPC}	-	-	1	ms	Unit time $3\mu s$ ¹⁾
Supply current	I_{DD}	3	6	8	mA	
Output current @ OUT shorted to supply lines	I_{OUTsh}	-	95	-	mA	$V_{OUT} = 5 V$, max. 10 minutes
Thermal resistance	R_{thJA}	-	190	-	K/W	Junction to air
	R_{thJC}	-	41	-	K/W	Junction to case
Power-on time ²⁾	t_{Pon}	-	0.7 15	2 20	ms	$\leq \pm 5\%$ target out value $\leq \pm 1\%$ target out value
Power-on reset level	V_{DDpon}	-	3.6	4	V	
Output impedance	Z_{OUT}	20	40	70	k Ω	³⁾
Output fall time	t_{fall}	2	-	4	μs	V_{OUT} 4.5 V to 0.5 V ⁴⁾
Output rise time	t_{rise}	-	20	-	μs	V_{OUT} 0.5 V to 4.5 V ⁴⁾⁵⁾
Output low saturation voltage	V_{OUTsat}	-	0.3 0.2	0.6 0.4	V	$I_{OUTsink} = 5 mA$ $I_{OUTsink} = 2.2 mA$
Output noise (rms)	OUT_{noise}	-	1	2.5	LSB ₁₂	⁶⁾

¹⁾ Transmission time depends on the data values being sent and on int. RC oscillator frequ. variation of +/- 20%

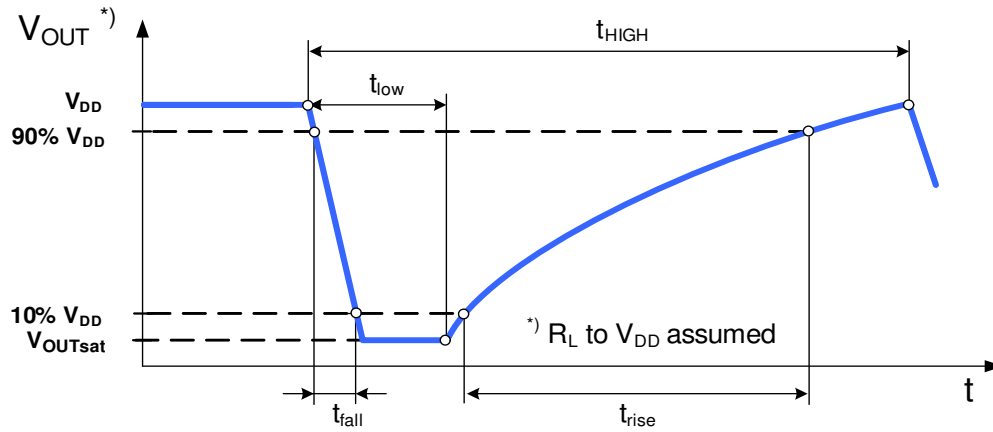
²⁾ Response time to set up output data at power on when a constant field is applied. The first value given has a $\pm 5\%$ error, the second value has a $\pm 1\%$ error. Measured with 640-Hz low-pass filter

³⁾ Output impedance is measured $\Delta V_{OUT}/\Delta I_{OUT}$ ($\Delta V_{OUT}=12V \dots 2.6V$) at $V_{DD} = 5V$, open-drain high state

⁴⁾ For $V_{DD} = 5 V$, $R_L = 2.2 k\Omega$, $C_L = 4.7 nF$ (in package), at room temperature, not considering condenser tolerance or influence of external circuitry

Electrical, Thermal, and Magnetic Parameters

5) Depends on external R_L and C_L



6) Range 100 mT, Gain 2.23, internal LP filter 244 Hz, B = 0 mT, T = 25 °C

Electrical, Thermal, and Magnetic Parameters

Calculation of the Junction Temperature

The internal power dissipation P_{TOT} of the sensor increases the chip junction temperature above the ambient temperature.

The power multiplied by the total thermal resistance R_{thJA} (Junction to Ambient) added to T_A leads to the final junction temperature. R_{thJA} is the sum of the addition of the two components, *Junction to Case* and *Case to Ambient*.

$$R_{thJA} = R_{thJC} + R_{thCA}$$

$$T_J = T_A + \Delta T$$

$$\Delta T = R_{thJA} \times P_{TOT} = R_{thJA} \times (V_{DD} \times I_{DD} + V_{OUT} \times I_{OUT}) \quad I_{DD}, I_{OUT} > 0, \text{ if direction is into IC}$$

Example (assuming no load on Vout):

- $V_{DD} = 5 \text{ V}$
- $I_{DD} = 8 \text{ mA}$
- $\Delta T = 190 \text{ [K/W]} \times (5 \text{ [V]} \times 0.008 \text{ [A]} + 0 \text{ [VA]}) = 7.6 \text{ K}$

For moulded sensors, the calculation with R_{thJC} is more adequate.

Magnetic Parameters

Table 5 Magnetic Characteristics

Parameter	Symbol	Limit Values			Unit	Notes
		min.	typ.	max.		
Sensitivity	$S^{1)}$	± 8.2	-	± 245	LSB ₁₂ /mT	Programmable ²⁾
Sensitivity drift	ΔS	-	± 80	± 150	ppm/ °C	³⁾ See Figure 4
Magnetic field range	MFR	± 50	$\pm 100^{4)}$	± 200	mT	Programmable ⁵⁾
Integral nonlinearity	INL	-	± 0.05	± 0.1	%MFR	⁶⁾⁸⁾
Magnetic offset	B_{OS}	-	-	± 400	μT	⁷⁾⁸⁾
Magnetic offset drift	ΔB_{OS}	-	± 1	± 5	μT / °C	Error band ⁸⁾
Magnetic hysteresis	B_{HYS}	-	-	10	μT	⁹⁾

1) Defined as $\Delta OUT / \Delta B$

2) Programmable in steps of 0.024%

3) For any 1st and 2nd order polynomial, coefficient within definition in Chapter 8. Valid for characterization at 0h

Electrical, Thermal, and Magnetic Parameters

- 4) This range is also used for temperature and offset pre-calibration of the IC
- 5) Depending on offset and gain settings, the output may already be saturated at lower fields
- 6) Gain setup is 1.0
- 7) In operating temperature range and over lifetime
- 8) Measured at ± 100 mT range
- 9) Measured in 100 mT range, Gain = 1, room temperature

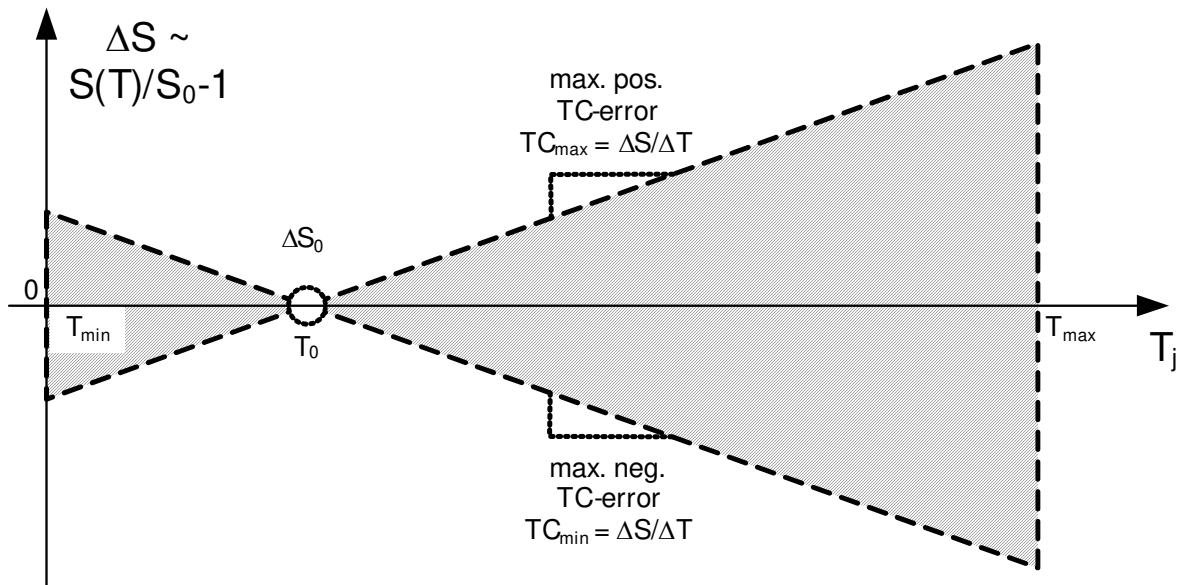


Figure 4 Sensitivity drift

6 Signal Processing

The signal flow diagram in [Figure 5](#) shows the signal path and data-processing algorithm.

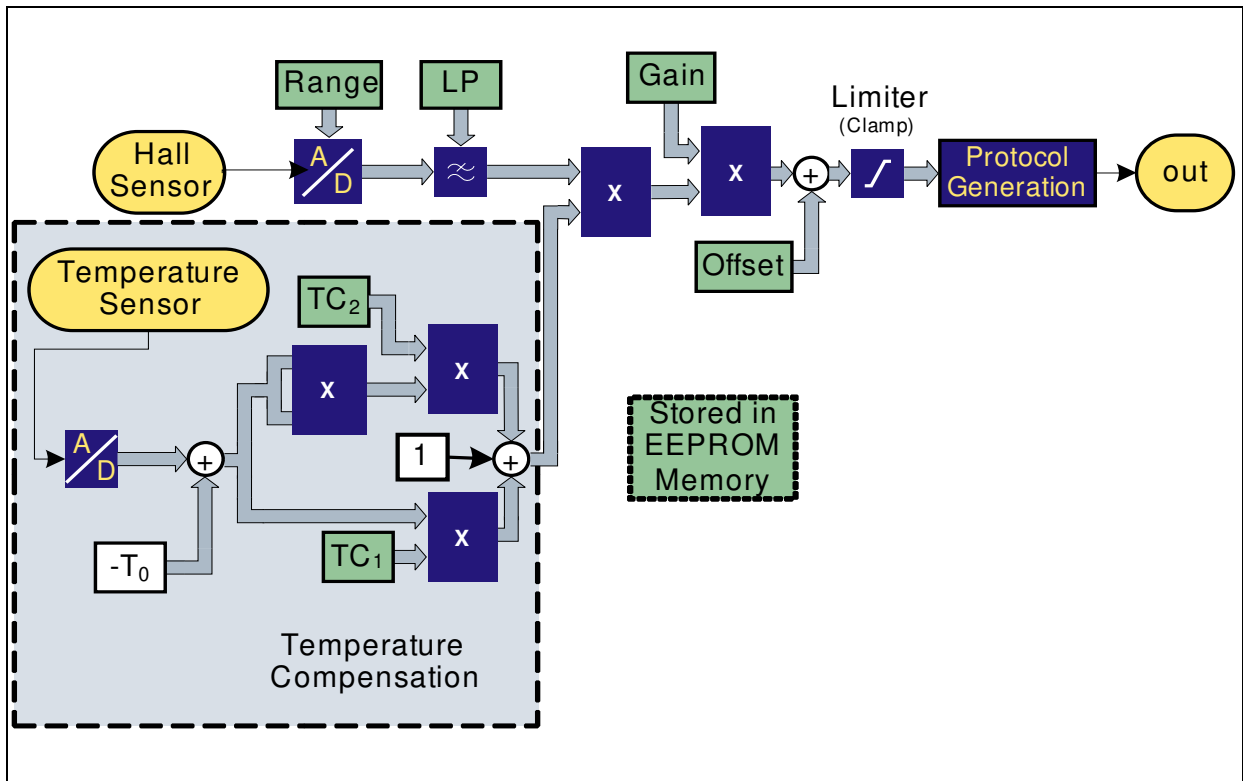


Figure 5 Signal Processing Flow

Magnetic Field Path

- The analog output signal of the chopped Hall-effect cell is converted to a digital signal in the continuous-time A/D converter. The range of the chopped A/D converter can be set in several steps either by EEPROM settings or dynamically by the master in the dynamic range mode (see [Table 6](#)). This gives a suitable level for the A/D converter
- After the A/D conversion, a digital low-pass filter reduces the bandwidth ([Table 10](#))
- A multiplier amplifies the value depending on the gain (see [Table 8](#)) and temperature compensation settings
- The offset value is added (see [Table 9](#))
- A limiter reduces the resulting signal to 16 bits (see [Chapter 12](#)) and feeds the Protocol Generation stage

Temperature Compensation

(Details are listed in [Chapter 8](#))

- The output signal of the temperature cell is also A/D converted

Signal Processing

- The temperature is normalized by subtraction of the reference temperature T_0 value (zero point of the quadratic function)
- The linear path is multiplied with the TC_1 value
- In the quadratic path, the temperature difference to T_0 is squared and multiplied with the TC_2 value
- Both path outputs are added together and multiplied with the Gain value from the EEPROM

6.1 Magnetic Field Ranges

The working range of the magnetic field defines the input range of the A/D converter. It is always symmetrical around the zero field point. Any two points in the magnetic field range can be selected to be the end points of the output value. The output value is represented within the range between the two points.

In the case of fields higher than the range values, the output signal may be distorted. In case of synchronous mode and ID selection mode the range must be set accordingly ($R=0/1/3$) before the calibration of offset and gain.

Table 6 Range Setting

Range	Range in mT ¹⁾	Parameter R
Low	± 50	3
Mid	± 100	1 ²⁾
High	± 200	0

1) Ranges do not have a guaranteed absolute accuracy. The temperature pre-calibration is performed in the mid range (100 mT)

2) Setting $R = 2$ is not used, internally changed to $R = 1$

Table 7 Range

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		
Register size	<i>R</i>	2		bit	

6.2 Gain Setting

The overall sensitivity is defined by the range and the gain setting. The output of the ADC is multiplied with the Gain value.

Table 8 Gain

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		
Register size	<i>G</i>	15		bit	Unsigned integer value
Gain range	<i>Gain</i>	- 4.0	3.9998	-	1)2)
Gain quantization steps	$\Delta Gain$	244.14		ppm	Corresponds to 1/4096

1) For Gain values between - 0.5 and + 0.5, the numerical accuracy decreases
To obtain a flatter output curve, it is advisable to select a higher range setting

2) A gain value of +1.0 corresponds to typical 32 LSB₁₂/mT sensitivity (100 mT range, not guaranteed). It is crucial to do a final calibration of each IC within the application using the Gain/OUT_{OS} value

The Gain value can be calculated by:

$$Gain = \frac{(G - 16384)}{4096}$$

6.3 Offset Setting

The offset value corresponds to an output value with zero field at the sensor.

Table 9 Offset

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		
Register size	<i>OS</i>	15		bit	Unsigned integer value
Offset range	<i>OUT_{OS}</i>	-16384	16383	LSB ₁₂	1)
Offset quantization steps	ΔOUT_{OS}	1		LSB ₁₂	

1) Infineon pre-calibrates the samples at zero field to 50% output value (100 mT range), but does not guarantee the value. Therefore it is crucial to do a final calibration of each IC within the application

The offset value can be calculated by:

$$OUT_{OS} = OS - 16384$$

6.4 DSP Input Low-Pass Filter

A digital low-pass filter is placed between the Hall A/D converter and the DSP, and can be used to reduce the noise level. The low-pass filter has a constant DC amplification of 0 dB (Gain of 1), which means that its setting has no influence on the internal Hall ADC value.

The bandwidth can be set to any of 8 values.

Table 10 Low Pass Filter Setting

<i>Note: Parameter LP</i>	Cutoff frequency in Hz (-3dB point) ¹⁾
0	80
1	240
2	440
3	640
4	860
5	1100
6	1390
7	off

¹⁾ As this is a digital filter running with an RC-based oscillator, the cutoff frequency may vary within $\pm 20\%$

Table 11 Low-Pass Filter

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		
Register size	<i>LP</i>	3		bit	
Corner frequency variation	Δf	- 20	+ 20	%	

Note: In range 7 (filter off), the output noise increases.

Signal Processing

Figure 6 shows the filter characteristics as a magnitude plot (the highest setting is marked). The “off” position would be a flat 0 dB line. The update rate after the low-pass filter is 16 kHz.

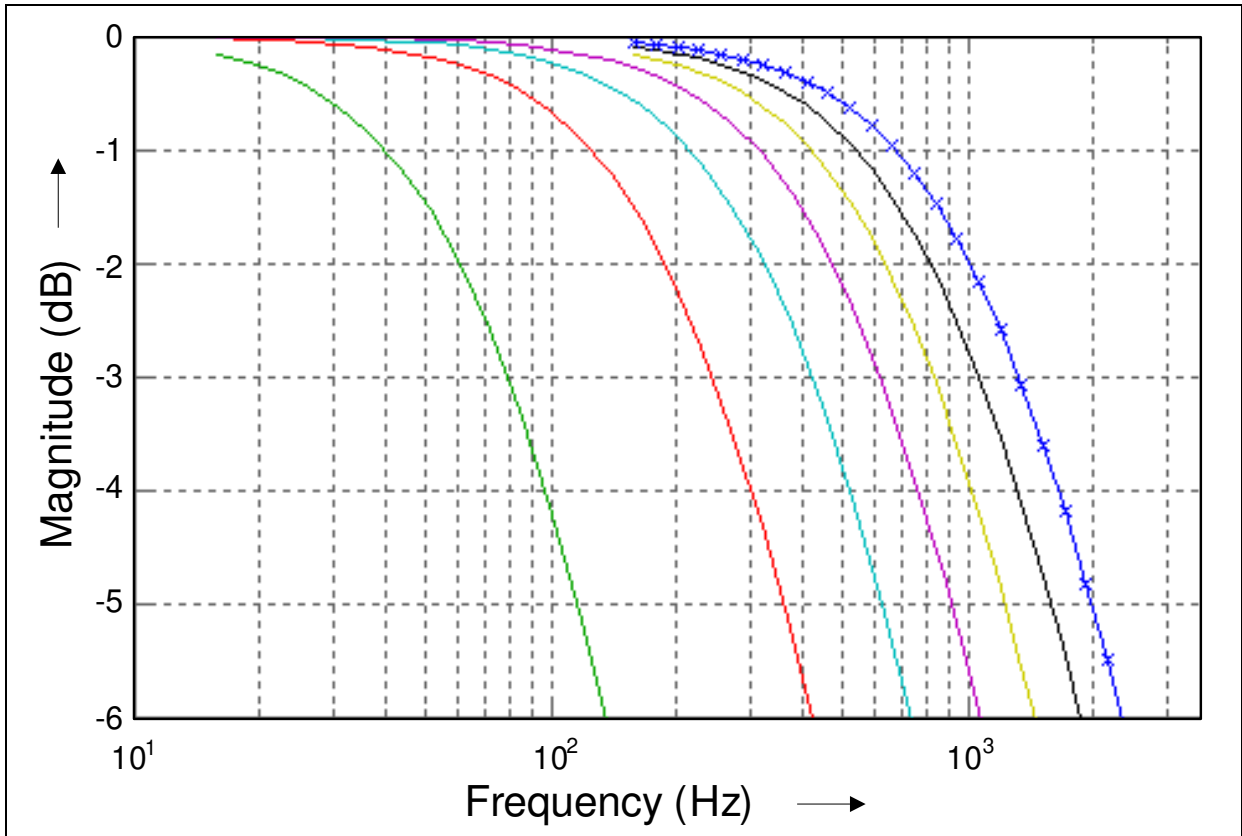


Figure 6 DSP Input Filter (Magnitude Plot)

6.5 Clamping

The clamping function is useful for separating the output range into an operating range and error ranges. If the magnetic field is exceeding the selected measurement range, the output value OUT is limited to the clamping values. Any value in the error range is interpreted as an error by the sensor counterpart.

Table 12 Clamping

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		
Register size	CL, CH	2 x 6		bit	(0...63)
Clamping value low	OUT_{CL}	0	64512	LSB ₁₆	¹⁾
Clamping value high	OUT_{CH}	1023	65535	LSB ₁₆	^{1) 2)}
Clamping quantization steps	ΔOUT_{Cx}	1024		LSB ₁₆	³⁾

¹⁾ For $CL = 0$ and $CH = 63$ the clamping function is disabled

²⁾ $OUT_{CL} < OUT_{CH}$ mandatory

³⁾ Quantization starts for CL at 0 LSB₁₆ and for CH at 65535 LSB₁₆

The clamping values are calculated by:

Clamping value low (deactivated if $CL=0$):

$$OUT_{CL} = CL \cdot 64 \cdot 16$$

Clamping value high (deactivated if $CH=63$):

$$OUT_{CH} = (CH + 1) \cdot 64 \cdot 16 - 1$$

Signal Processing

Figure 7 shows an example in which the magnetic field range between B_{min} and B_{max} is mapped to output values between 10240 LSB_{16} and 55295 LSB_{16} .

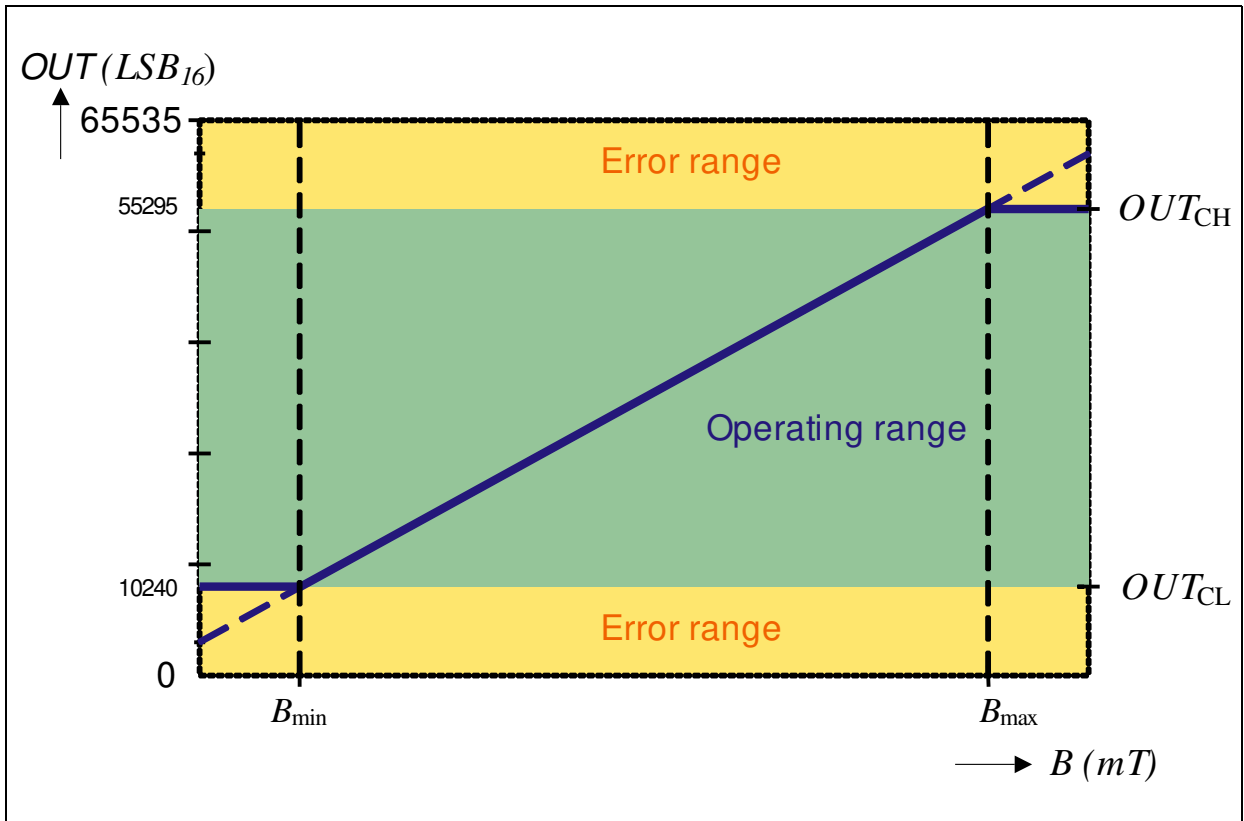


Figure 7 Clamping Example

Note: The clamping high value must be above the low value.

7 Error Detection

Different error cases can be detected by the On-Board Diagnostics (OBD) and reported to the microcontroller in the status nibble (see [Chapter 12](#)).

7.1 Voltages Outside the Operating Range

The output signals an error condition if V_{DD} crosses the overvoltage threshold level.

Table 13 Overvoltage

Parameter	Symbol	Limit Values			Unit	Notes
		min.	typ.	max.		
Overvoltage threshold	V_{DDov}	16.65	17.5	18.35	V	1)

1) Overvoltage bit activated in status nibble, output stays in “off” state (high ohmic)

7.2 EEPROM Error Correction

The parity method is able to correct a single bit in the EEPROM line. One other single bit error in another EEPROM line can also be detected, but not corrected. In an uncorrectable EEPROM failure, the open drain stage is disabled and kept in the off state permanently (high ohmic/sensor defect).

Temperature Compensation

8 Temperature Compensation

The magnetic field strength of a magnet depends on the temperature. This material constant is specific for the different magnet types. Therefore, the TLE4998C3C offers a second-order temperature compensation polynomial, by which the Hall signal output is multiplied in the DSP. There are three parameters for the compensation:

- Reference temperature T_0
- A linear part (1st order) TC_1
- A quadratic part (2nd order) TC_2

The following formula describes the sensitivity dependent on the temperature in relation to the sensitivity at the reference temperature T_0 :

$$S_{TC}(T) = 1 + TC_1 \times (T - T_0) + TC_2 \times (T - T_0)^2$$

For more information, please refer to the signal processing flow in [Figure 5](#).

The full temperature compensation of the complete system is done in two steps:

1. Pre-calibration in the Infineon final test

The parameters TC_1 , TC_2 , T_0 are set to maximally flat temperature characteristics with respect to the Hall probe and internal analog processing parts.

2. Overall system calibration

The typical coefficients TC_1 , TC_2 , T_0 of the magnetic circuitry are programmed. This can be done deterministically, as the algorithm of the DSP is fully reproducible. The final setting of the TC_1 , TC_2 , T_0 values depend on the pre-calibrated values.

Table 14 Temperature Compensation

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		
Register size TC_1	TL	-	9	bit	Unsigned integer values
1 st order coefficient TC_1	TC_1	-1000	2500	ppm/ °C	1)
Quantization steps of TC_1	qTC_1	15.26		ppm/ °C	
Register size TC_2	TQ	-	8	bit	Unsigned integer values
2 nd order coefficient TC_2	TC_2	- 4	4	ppm/ °C ²	2)
Quantization steps of TC_2	qTC_2	0.119		ppm/ °C ²	
Reference temp.	T_0	- 48	64	°C	
Quantization steps of T_0	qT_0	1		°C	3)

1) Relative range to Infineon TC_1 temperature pre-calibration, the maximum adjustable range is limited by the register-size and depends on specific pre-calibrated TL setting, full adjustable range: -2441 to +5355 ppm/°C

2) Relative range to Infineon TC_2 temperature pre-calibration, the maximum adjustable range is limited by the register-size and depends on specific pre-calibrated TQ setting, full adjustable range: -15 to +15 ppm/°C²